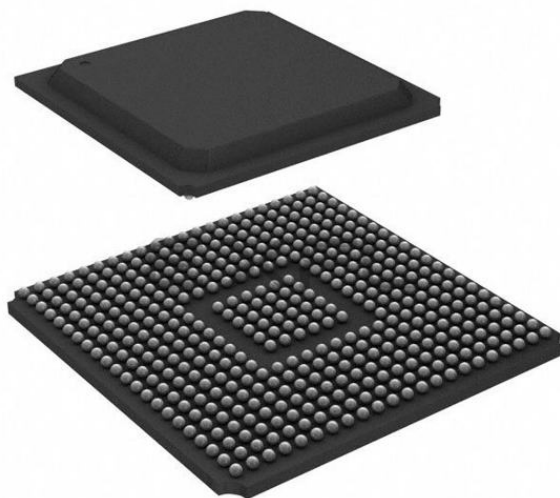




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Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	1232
Number of Logic Elements/Cells	11088
Total RAM Bits	811008
Number of I/O	248
Number of Gates	-
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	456-BBGA
Supplier Device Package	456-FBGA (23x23)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2vp7-6fgg456i

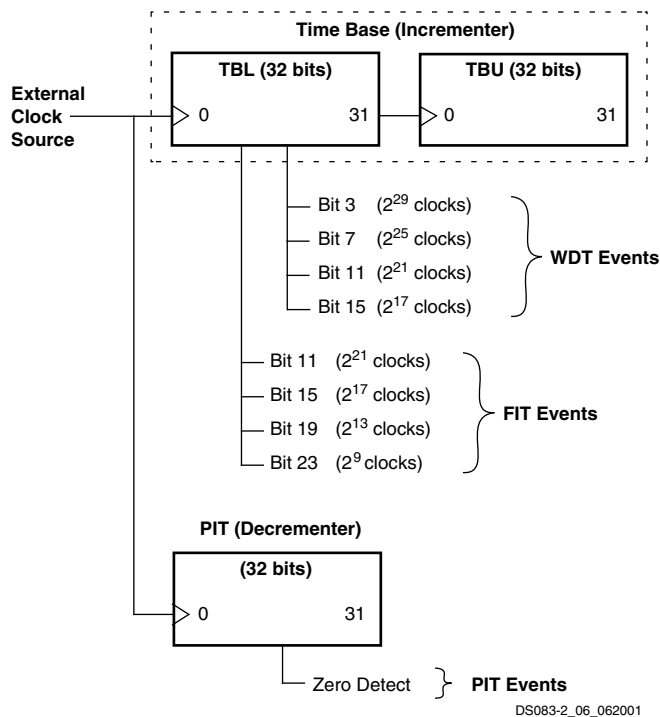


Figure 17: Relationship of Timer Facilities to Base Clock

Interrupts

The PPC405 provides an interface to an interrupt controller that is logically outside the PPC405 core. This controller combines the asynchronous interrupt inputs and presents them to the embedded core as a single interrupt signal. The sources of asynchronous interrupts are external signals, the JTAG/debug unit, and any implemented peripherals.

Debug Logic

All architected resources on the embedded PPC405 core can be accessed through the debug logic. Upon a debug event, the PPC405 core provides debug information to an external debug tool. Three different types of tools are supported depending on the debug mode: ROM monitors, JTAG debuggers, and instruction trace tools.

In internal debug mode, a debug event enables exception-handling software at a dedicated interrupt vector to take

over the CPU core and communicate with a debug tool. The debug tool has read-write access to all registers and can set hardware or software breakpoints. ROM monitors typically use the internal debug mode.

In external debug mode, the CPU core enters stop state (stops instruction execution) when a debug event occurs. This mode offers a debug tool read-write access to all registers in the PPC405 core. Once the CPU core is in stop state, the debug tool can start the CPU core, step an instruction, freeze the timers, or set hardware or software breakpoints. In addition to CPU core control, the debug logic is capable of writing instructions into the instruction cache, eliminating the need for external memory during initial board bring-up. Communication to a debug tool using external debug mode is through the JTAG port.

Debug wait mode offers the same functionality as external debug mode with one exception. In debug wait mode, the CPU core goes into wait state instead of stop state after a debug event. Wait state is identical to stop state until an interrupt occurs. In wait state, the PPC405 core can vector to an exception handler, service an interrupt and return to wait state. This mode is particularly useful when debugging real time control systems.

Real-time trace debug mode is always enabled. The debug logic continuously broadcasts instruction trace information to the trace port. When a debug event occurs, the debug logic signals an external debug tool to save instruction trace information before and after the event. The number of instructions traced depends on the trace tool.

Debug events signal the debug logic to stop the CPU core, put the CPU core in debug wait state, cause a debug exception or save instruction trace information.

Big Endian and Little Endian Support

The embedded PPC405 core supports big endian or little endian byte ordering for instructions stored in external memory. Since the PowerPC architecture is big endian internally, the ICU rearranges the instructions stored as little endian into the big endian format. Therefore, the instruction cache always contains instructions in big endian format so that the byte ordering is correct for the execution unit. This feature allows the 405 core to be used in systems designed to function in a little endian environment.

synchronously. The sequence can also be paused at any stage, until lock has been achieved on any or all DCMs, as well as DCI.

Readback

In this mode, configuration data from the Virtex-II Pro FPGA device can be read back. Readback is supported only in the SelectMAP (master and slave) and Boundary-Scan mode.

Along with the configuration data, it is possible to read back the contents of all registers, distributed SelectRAM+, and block RAM resources. This capability is used for real-time debugging. For more detailed configuration information, see the *Virtex-II Pro Platform FPGA User Guide*.

Bitstream Encryption

Virtex-II Pro devices have an on-chip decryptor using one or two sets of three keys for triple-key Data Encryption Standard (DES) operation. Xilinx software tools offer an optional encryption of the configuration data (bitstream) with a triple-key DES determined by the designer.

The keys are stored in the FPGA by JTAG instruction and retained by a battery connected to the V_{BATT} pin, when the device is not powered. Virtex-II Pro devices can be config-

ured with the corresponding encrypted bitstream, using any of the configuration modes described previously.

A detailed description of how to use bitstream encryption is provided in the [Virtex-II Pro Platform FPGA User Guide](#). Your local FAE can also provide specific information on this feature.

Partial Reconfiguration

Partial reconfiguration of Virtex-II Pro devices can be accomplished in either Slave SelectMAP mode or Boundary-Scan mode. Instead of resetting the chip and doing a full configuration, new data is loaded into a specified area of the chip, while the rest of the chip remains in operation. Data is loaded on a column basis, with the smallest load unit being a configuration “frame” of the bitstream (device size dependent).

Partial reconfiguration is useful for applications that require different designs to be loaded into the same area of a chip, or that require the ability to change portions of a design without having to reset or reconfigure the entire chip.

For more information on Partial Reconfiguration in Virtex-II Pro devices, please refer to Xilinx Application Note [XAPP290](#), *Two Flows for Partial Reconfiguration*.

Revision History

This section records the change history for this module of the data sheet.

Date	Version	Revision
01/31/02	1.0	Initial Xilinx release.
06/13/02	2.0	New Virtex-II Pro family members. New timing parameters per speedsfile v1.62 .
09/03/02	2.1	- Revised Reset and Power sections. - Updated Table 8, which lists compatible input standards. [Table deleted in v2.6.] - Added Figure 28, Figure 29, and Figure 30, which provide examples illustrating the use of I/O standards.
09/27/02	2.2	- In section RocketIO Overview, corrected max number of MGTs from 16 to 24. - In section Input/Output Blocks (IOBs), added references to XAPP653 regarding implementation of 3.3V I/O standards.
11/20/02	2.3	Table 8: Added rows for LVTTTL, LVCMOS33, and PCI-X. Table 8: Added LVTTTL and LVCMOS33 to compatible 3.3V cells. [Table deleted in v2.6.] Table 33: Correct bitstream lengths.
12/03/02	2.4	Added mention of LVTTTL and PCI with respect to SelectIO-Ultra configurations. See section Input/Output Individual Options and Figure 22.
01/20/03	2.5	- Added qualification to features vs. Virtex-II (open-drain output pin TDO does not have internal pull-up resistor) - Table 7: Added HSTL18 (I, II, III, & IV) and HSTL18_DCI (I,II, III & IV) to 1.8V VCCO row. [Table deleted in v2.6.] - Table 8: Numerous revisions. [Table deleted in v2.6.]

Date	Version	Revision
10/10/05	4.5	Changed XC2VPX70 variable baud rate specification to fixed-rate operation at 4.25 Gb/s.
03/05/07	4.6	<i>No changes in Module 2 for this revision.</i>
11/05/07	4.7	- Updated copyright notice and legal disclaimer. Debug Interface, page 19, and Boundary-Scan (JTAG, IEEE 1532) Mode, page 57: Updated IEEE 1149.1 compliance statement.
06/21/11	5.0	Added <i>Product Not Recommended for New Designs</i> banner.

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Virtex-II Pro Data Sheet

The Virtex-II Pro Data Sheet contains the following modules:

- Virtex-II Pro and Virtex-II Pro X Platform FPGAs: Introduction and Overview (Module 1)
- Virtex-II Pro and Virtex-II Pro X Platform FPGAs: Functional Description (Module 2)
- Virtex-II Pro and Virtex-II Pro X Platform FPGAs: DC and Switching Characteristics (Module 3)
- Virtex-II Pro and Virtex-II Pro X Platform FPGAs: Pinout Information (Module 4)

Virtex-II Pro Pin-to-Pin Output Parameter Guidelines

All devices are 100% functionally tested. Listed below are representative values for typical pin locations and normal clock loading. Values are expressed in nanoseconds unless otherwise noted.

Global Clock Input to Output Delay for LVCMOS25, 12 mA, Fast Slew Rate, With DCM

Table 53: Global Clock Input to Output Delay for LVCMOS25, 12 mA, Fast Slew Rate, With DCM

			Speed Grade			
Description	Symbol	Device	-7	-6	-5	Units
LVC MOS25 Global Clock Input to Output Delay using Output Flip-flop, 12 mA, Fast Slew Rate, <i>with</i> DCM. For data <i>output</i> with different standards, adjust the delays with the values shown in IOB Output Switching Characteristics Standard Adjustments , page 28.						
Global Clock and OFF with DCM	T _{ICKOFFDCM}	XC2VP2	1.55	1.59	1.62	ns
		XC2VP4	1.58	1.61	1.65	ns
		XC2VP7	1.63	1.68	1.72	ns
		XC2VP20	1.68	1.74	1.79	ns
		XC2VPX20	1.68	1.74	1.79	ns
		XC2VP30	1.68	1.75	1.80	ns
		XC2VP40	1.71	1.86	1.92	ns
		XC2VP50	1.80	2.00	2.07	ns
		XC2VP70	1.87	2.07	2.24	ns
		XC2VPX70	1.87	2.07	2.24	ns
		XC2VP100	N/A	2.38	2.45	ns

Notes:

1. Listed above are representative values where one global clock input drives one vertical clock line in each accessible column, and where all accessible IOB and CLB flip-flops are clocked by the global clock net.
2. Output timing is measured at 50% V_{CC} threshold with test setup shown in [Figure 6](#). For other I/O standards, see [Table 40](#).
3. DCM output jitter is already included in the timing calculation.

Date	Version	Revision
09/15/05	4.4	Table 2: Added Footnote (7) to AVCCAUXRX for RocketIO X (1.8V for all non-8B/10B-encoded data). Table 3: - Power dissipation for 10.3125 Gb/s deleted. - Max $I_{CCAUXTX}$ and $I_{CCAUXRX}$ specifications added for Virtex-II Pro. Table 11: Added specification for minimum p-p differential input voltage. Table 22: F_{GCLK}: Changed high end of range to 425 MHz. T_{GJTT}: Changed measurement units to picoseconds and added maximum specifications for two bit rate ranges. T_{LOCK}: Changed measurement units to microseconds and added typical specification. T_{PHASE}: Changed measurement units to microseconds and added typical and maximum specifications. Table 24: - All parameters: Deleted specifications for 10.3125 Gb/s. T_{RJTO}: Added typical specifications. T_{JTOL}, T_{SJTOL}, and T_{DDJTOL}: Added typical and maximum specifications. Table 26: Restructured table. Total Jitter parameter added. All jitter parameters respecified. Table 28: Restructured table and added new specifications.
10/10/05	4.5	- Changed XC2VPX70 variable baud rate specification to fixed-rate operation at 4.25 Gb/s. Table 15: Removed -7 designations for XC2VPX20 and XC2VPX70 devices.
03/05/07	4.6	<i>No changes in Module 3 for this revision.</i>
11/05/07	4.7	Updated copyright notice and legal disclaimer.
06/21/11	5.0	Added <i>Product Not Recommended for New Designs</i> banner. Changed I_{TRX} typical value in Table 3 .

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- Virtex-II Pro and Virtex-II Pro X Platform FPGAs: Pinout Information (Module 4)

Table 5: FG256/FGG256 — XC2VP2 and XC2VP4

Bank	Pin Description	Pin Number
N/A	AVCCAUXRX7	B13
N/A	AVCCAUXRX18	R13
N/A	VTRXPAD18	R12
N/A	RXNPAD18	T13
N/A	RXPPAD18	T12
N/A	GNDA18	P11
N/A	TXPPAD18	T11
N/A	TXNPAD18	T10
N/A	VTTXPAD18	R10
N/A	AVCCAUXTX18	R11
N/A	AVCCAUXRX19	R7
N/A	VTRXPAD19	R6
N/A	RXNPAD19	T7
N/A	RXPPAD19	T6
N/A	GNDA19	P6
N/A	TXPPAD19	T5
N/A	TXNPAD19	T4
N/A	VTTXPAD19	R4
N/A	AVCCAUXTX19	R5
N/A	VCCINT	N4
N/A	VCCINT	N13
N/A	VCCINT	M5
N/A	VCCINT	M12
N/A	VCCINT	E5
N/A	VCCINT	E12
N/A	VCCINT	D4
N/A	VCCINT	D13
N/A	VCCAUX	R16
N/A	VCCAUX	R1
N/A	VCCAUX	B16
N/A	VCCAUX	B1
N/A	GND	T16
N/A	GND	T1
N/A	GND	R2

Table 7: FG676/FGG676 — XC2VP20, XC2VP30, and XC2VP40

Bank	Pin Description	Pin Number	No Connects		
			XC2VP20	XC2VP30	XC2VP40
6	IO_L55P_6	T2			
6	IO_L55N_6	T1			
6	IO_L57P_6	R9			
6	IO_L57N_6/VREF_6	R8			
6	IO_L59P_6	R6			
6	IO_L59N_6	P6			
6	IO_L60P_6	R5			
6	IO_L60N_6	R4			
6	IO_L85P_6	R2			
6	IO_L85N_6	R1			
6	IO_L87P_6	P9			
6	IO_L87N_6/VREF_6	P8			
6	IO_L89P_6	P5			
6	IO_L89N_6	P4			
6	IO_L90P_6	P3			
6	IO_L90N_6	P2			
7	IO_L90P_7	N2			
7	IO_L90N_7	N3			
7	IO_L88P_7	N4			
7	IO_L88N_7/VREF_7	N5			
7	IO_L86P_7	N8			
7	IO_L86N_7	N9			
7	IO_L85P_7	M1			
7	IO_L85N_7	M2			
7	IO_L60P_7	M4			
7	IO_L60N_7	M5			
7	IO_L58P_7	N6			
7	IO_L58N_7/VREF_7	M6			
7	IO_L56P_7	M8			
7	IO_L56N_7	M9			
7	IO_L55P_7	L1			
7	IO_L55N_7	L2			
7	IO_L54P_7	L5			
7	IO_L54N_7	L6			

Table 8: FF672 — XC2VP2, XC2VP4, and XC2VP7

Bank	Pin Description	Pin Number	No Connects		
			XC2VP2	XC2VP4	XC2VP7
5	IO_L74P_5/GCLK4P	AB14			
5	IO_L73N_5	AA14			
5	IO_L73P_5	Y14			
5	IO_L69N_5/VREF_5	W14			
5	IO_L69P_5	W15			
5	IO_L68N_5	AD15			
5	IO_L68P_5	AC15			
5	IO_L67N_5	AB15			
5	IO_L67P_5	AA15			
5	IO_L45N_5/VREF_5	AC16	NC	NC	
5	IO_L45P_5	AB16	NC	NC	
5	IO_L44N_5	Y15	NC	NC	
5	IO_L44P_5	Y16	NC	NC	
5	IO_L43N_5	AC17	NC	NC	
5	IO_L43P_5	AB17	NC	NC	
5	IO_L39N_5	AA16	NC	NC	
5	IO_L39P_5	AA17	NC	NC	
5	IO_L38N_5	W16	NC	NC	
5	IO_L38P_5	Y17	NC	NC	
5	IO_L37N_5	AD18	NC	NC	
5	IO_L37P_5	AC18	NC	NC	
5	IO_L09N_5/VREF_5	AA18			
5	IO_L09P_5	Y18			
5	IO_L08N_5	AF19			
5	IO_L08P_5	AE19			
5	IO_L07N_5/VREF_5	AD19			
5	IO_L07P_5	AC19			
5	IO_L06N_5/VRP_5	AB18			
5	IO_L06P_5/VRN_5	AB19			
5	IO_L05_5/No_Pair	Y19			
5	IO_L03N_5/D4	AA19			
5	IO_L03P_5/D5	AA20			
5	IO_L02N_5/D6	AC20			
5	IO_L02P_5/D7	AB20			
5	IO_L01N_5/RDWR_B	AD21			
5	IO_L01P_5/CS_B	AC21			

Table 9: FF896 — XC2VP7, XC2VP20, XC2VPX20, and XC2VP30

Bank	Pin Description		Pin Number	No Connects		
	Virtex-II Pro devices	XC2VPX20 (if Different)		XC2VP7	XC2VP20, XC2VPX20	XC2VP30
N/A	GND		U18			
N/A	GND		U17			
N/A	GND		U16			
N/A	GND		U15			
N/A	GND		U14			
N/A	GND		U13			
N/A	GND		U12			
N/A	GND		U6			
N/A	GND		T19			
N/A	GND		T18			
N/A	GND		T17			
N/A	GND		T16			
N/A	GND		T15			
N/A	GND		T14			
N/A	GND		T13			
N/A	GND		T12			
N/A	GND		R19			
N/A	GND		R18			
N/A	GND		R17			
N/A	GND		R16			
N/A	GND		R15			
N/A	GND		R14			
N/A	GND		R13			
N/A	GND		R12			
N/A	GND		P25			
N/A	GND		P19			
N/A	GND		P18			
N/A	GND		P17			
N/A	GND		P16			
N/A	GND		P15			
N/A	GND		P14			
N/A	GND		P13			
N/A	GND		P12			
N/A	GND		P6			
N/A	GND		N19			
N/A	GND		N18			

FF1152 Flip-Chip Fine-Pitch BGA Package Specifications (1.00mm pitch)

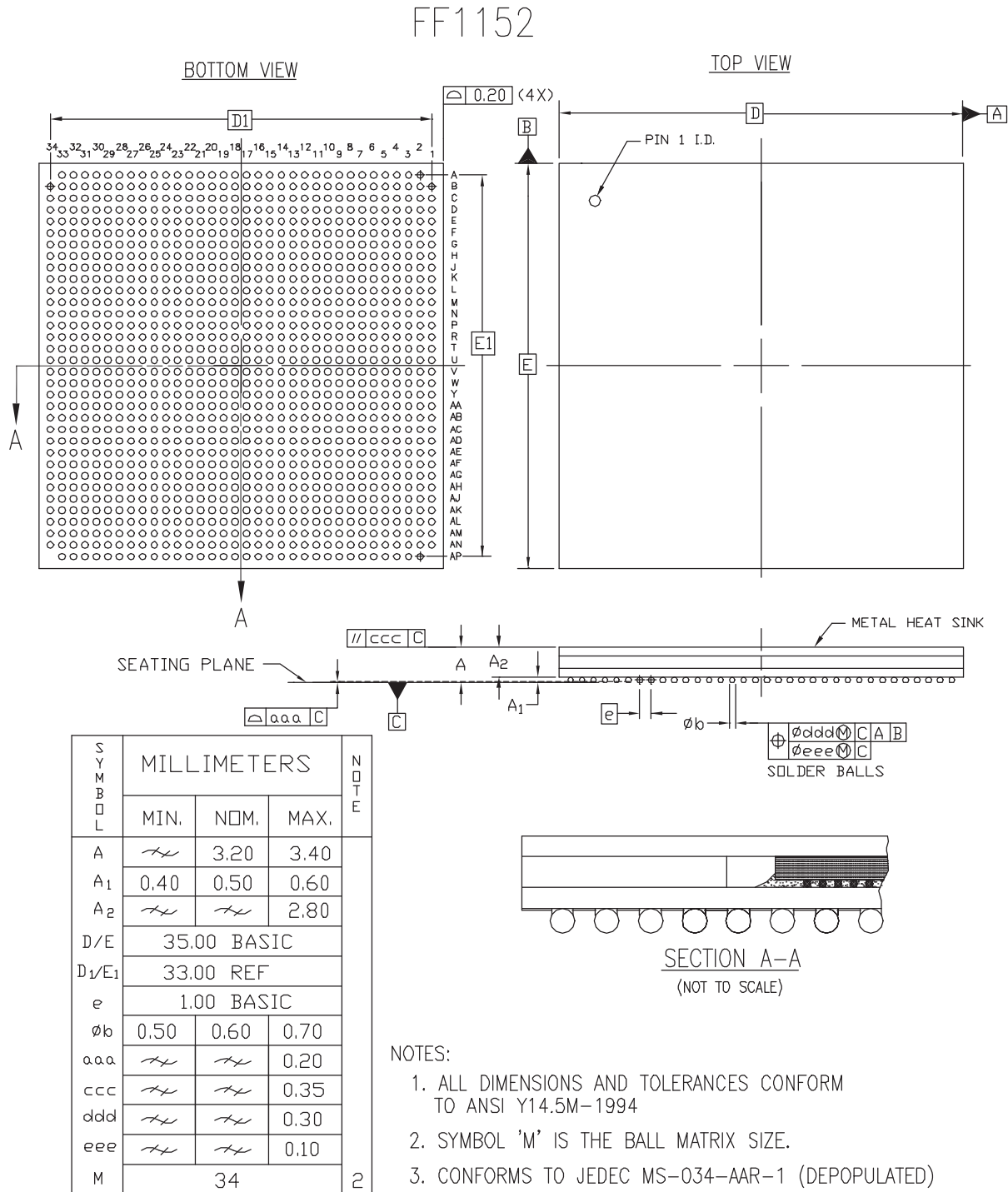


Figure 6: FF1152 Flip-Chip Fine-Pitch BGA Package Specifications

Table 11: FF1148 — XC2VP40 and XC2VP50

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
5	IO_L27P_5	AL23		
5	IO_L26N_5	AD22		
5	IO_L26P_5	AE22		
5	IO_L25N_5	AJ23		
5	IO_L25P_5	AK23		
5	IO_L21N_5	AN24		
5	IO_L21P_5	AP24		
5	IO_L20N_5	AE23		
5	IO_L20P_5	AF23		
5	IO_L19N_5	AM23		
5	IO_L19P_5	AM24		
5	IO_L09N_5/VREF_5	AJ24		
5	IO_L09P_5	AK24		
5	IO_L08N_5	AG22		
5	IO_L08P_5	AG23		
5	IO_L07N_5/VREF_5	AH23		
5	IO_L07P_5	AH24		
5	IO_L06N_5/VRP_5	AN25		
5	IO_L06P_5/VRN_5	AP25		
5	IO_L05_5/No_Pair	AH25		
5	IO_L03N_5/D4	AL25		
5	IO_L03P_5/D5	AM25		
5	IO_L02N_5/D6	AE24		
5	IO_L02P_5/D7	AF24		
5	IO_L01N_5/RDWR_B	AJ25		
5	IO_L01P_5/CS_B	AK25		
6	IO_L01P_6/VRN_6	AP32		
6	IO_L01N_6/VRP_6	AN32		
6	IO_L02P_6	AP28		
6	IO_L02N_6	AN28		
6	IO_L03P_6	AP31		
6	IO_L03N_6/VREF_6	AN31		
6	IO_L04P_6	AP29		
6	IO_L04N_6	AN29		
6	IO_L05P_6	AN26		
6	IO_L05N_6	AN27		
6	IO_L06P_6	AM33		

Table 11: FF1148 — XC2VP40 and XC2VP50

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
7	IO_L51P_7	N31		
7	IO_L51N_7	P31		
7	IO_L50P_7	T27		
7	IO_L50N_7	R28		
7	IO_L49P_7	M33		
7	IO_L49N_7	M34		
7	IO_L48P_7	M31		
7	IO_L48N_7	M32		
7	IO_L47P_7	R24		
7	IO_L47N_7	R25		
7	IO_L46P_7	M29		
7	IO_L46N_7/VREF_7	M30		
7	IO_L45P_7	L33		
7	IO_L45N_7	L34		
7	IO_L44P_7	P27		
7	IO_L44N_7	P28		
7	IO_L43P_7	L29		
7	IO_L43N_7	L30		
7	IO_L42P_7	K33		
7	IO_L42N_7	K34		
7	IO_L41P_7	P26		
7	IO_L41N_7	R26		
7	IO_L40P_7	K32		
7	IO_L40N_7/VREF_7	L32		
7	IO_L39P_7	K29		
7	IO_L39N_7	K30		
7	IO_L38P_7	P24		
7	IO_L38N_7	P25		
7	IO_L37P_7	J32		
7	IO_L37N_7	J33		
7	IO_L36P_7	J31		
7	IO_L36N_7	K31		
7	IO_L35P_7	N28		
7	IO_L35N_7	N29		
7	IO_L34P_7	H32		
7	IO_L34N_7/VREF_7	H33		
7	IO_L33P_7	H29		
7	IO_L33N_7	H30		

Table 11: FF1148 — XC2VP40 and XC2VP50

Bank	Pin Description	Pin Number	No Connects	
			XC2VP40	XC2VP50
N/A	GND	AP5		
N/A	GND	AK5		
N/A	GND	AF5		
N/A	GND	AB5		
N/A	GND	W5		
N/A	GND	T5		
N/A	GND	N5		
N/A	GND	J5		
N/A	GND	E5		
N/A	GND	A5		
N/A	GND	AM3		
N/A	GND	C3		
N/A	GND	AN2		
N/A	GND	B2		
N/A	GND	AK1		
N/A	GND	AF1		
N/A	GND	AB1		
N/A	GND	W1		
N/A	GND	V1		
N/A	GND	T1		
N/A	GND	N1		
N/A	GND	J1		
N/A	GND	E1		

Notes:

1. See [Table 4](#) for an explanation of the signals available on this pin.

Table 12: FF1517 — XC2VP50 and XC2VP70

Bank	Pin Description	Pin Number	No Connects	
			XC2VP50	XC2VP70
4	IO_L03N_4/D2	AN10		
4	IO_L03P_4/D3	AM10		
4	IO_L05_4/No_Pair	AK10		
4	IO_L06N_4/VRP_4	AR10		
4	IO_L06P_4/VRN_4	AP10		
4	IO_L07N_4	AU10		
4	IO_L07P_4/VREF_4	AT10		
4	IO_L08N_4	AJ12		
4	IO_L08P_4	AJ13		
4	IO_L09N_4	AL10		
4	IO_L09P_4/VREF_4	AL11		
4	IO_L19N_4	AN11		
4	IO_L19P_4	AM11		
4	IO_L20N_4	AH13		
4	IO_L20P_4	AH14		
4	IO_L21N_4	AR11		
4	IO_L21P_4	AP11		
4	IO_L25N_4	AU11		
4	IO_L25P_4	AT11		
4	IO_L26N_4	AL14		
4	IO_L26P_4	AK14		
4	IO_L27N_4	AM12		
4	IO_L27P_4/VREF_4	AL12		
4	IO_L28N_4	AT12	NC	
4	IO_L28P_4	AR12	NC	
4	IO_L29N_4	AJ14	NC	
4	IO_L29P_4	AJ15	NC	
4	IO_L30N_4	AM13	NC	
4	IO_L30P_4	AL13	NC	
4	IO_L34N_4	AP12	NC	
4	IO_L34P_4	AN13	NC	
4	IO_L35N_4	AL15	NC	
4	IO_L35P_4	AK15	NC	
4	IO_L36N_4	AT13	NC	
4	IO_L36P_4/VREF_4	AR13	NC	
4	IO_L37N_4	AN14		
4	IO_L37P_4	AM14		
4	IO_L38N_4	AH15		

Table 13: FF1704 — XC2VP70, XC2VPX70, and XC2VP100

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
1	IO_L48N_1		J17		
1	IO_L48P_1		H17		
1	IO_L47N_1		K17		
1	IO_L47P_1		L17		
1	IO_L46N_1		M17		
1	IO_L46P_1		M18		
1	IO_L45N_1/VREF_1		F16		
1	IO_L45P_1		E16		
1	IO_L44N_1		G16		
1	IO_L44P_1		H16		
1	IO_L43N_1		K16		
1	IO_L43P_1		J16		
1	IO_L39N_1		M16		
1	IO_L39P_1		L16		
1	IO_L38N_1		C15		
1	IO_L38P_1		C14		
1	IO_L37N_1		F15		
1	IO_L37P_1		E15		
1	IO_L87N_1/VREF_1		J15	NC	
1	IO_L87P_1		H15	NC	
1	IO_L86N_1		K15	NC	
1	IO_L86P_1		L15	NC	
1	IO_L85N_1		E14	NC	
1	IO_L85P_1		D14	NC	
1	IO_L84N_1		G14	NC	
1	IO_L84P_1		F14	NC	
1	IO_L83_1/No_Pair		H14	NC	
1	IO_L78N_1		L14	NC	
1	IO_L78P_1		K14	NC	
1	IO_L36N_1/VREF_1		M14		
1	IO_L36P_1		M15		
1	IO_L35N_1		C13		
1	IO_L35P_1		D13		
1	IO_L34N_1		F13		
1	IO_L34P_1		E13		
1	IO_L30N_1		H13		

Table 13: FF1704 — XC2VP70, XC2VPX70, and XC2VP100

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
7	IO_L87P_7		AA33		
7	IO_L87N_7		AA34		
7	IO_L86P_7		Y31		
7	IO_L86N_7		Y32		
7	IO_L85P_7		Y39		
7	IO_L85N_7		Y40		
7	IO_L60P_7		Y36		
7	IO_L60N_7		Y37		
7	IO_L59P_7		Y33		
7	IO_L59N_7		Y34		
7	IO_L58P_7		W41		
7	IO_L58N_7/VREF_7		W42		
7	IO_L57P_7		W39		
7	IO_L57N_7		W40		
7	IO_L56P_7		W31		
7	IO_L56N_7		W32		
7	IO_L55P_7		W37		
7	IO_L55N_7		W38		
7	IO_L54P_7		W35		
7	IO_L54N_7		W36		
7	IO_L53P_7		W33		
7	IO_L53N_7		W34		
7	IO_L52P_7		V41		
7	IO_L52N_7/VREF_7		V42		
7	IO_L51P_7		V38		
7	IO_L51N_7		V39		
7	IO_L50P_7		V31		
7	IO_L50N_7		U32		
7	IO_L49P_7		V35		
7	IO_L49N_7		V36		
7	IO_L48P_7		V32		
7	IO_L48N_7		V33		
7	IO_L47P_7		U31		
7	IO_L47N_7		T31		
7	IO_L46P_7		U41		
7	IO_L46N_7/VREF_7		U42		

Table 13: FF1704 — XC2VP70, XC2VPX70, and XC2VP100

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
N/A	VCCINT		AF16		
N/A	VCCINT		AG27		
N/A	VCCINT		AG26		
N/A	VCCINT		AG25		
N/A	VCCINT		AG24		
N/A	VCCINT		AG23		
N/A	VCCINT		AG22		
N/A	VCCINT		AG21		
N/A	VCCINT		AG20		
N/A	VCCINT		AG19		
N/A	VCCINT		AG18		
N/A	VCCINT		AG17		
N/A	VCCINT		AG16		
N/A	VCCINT		AH28		
N/A	VCCINT		AH27		
N/A	VCCINT		AH26		
N/A	VCCINT		AH17		
N/A	VCCINT		AH16		
N/A	VCCINT		AH15		
N/A	VCCINT		AJ29		
N/A	VCCINT		AJ28		
N/A	VCCINT		AJ27		
N/A	VCCINT		AJ16		
N/A	VCCINT		AJ15		
N/A	VCCINT		AJ14		
N/A	VCCINT		AK30		
N/A	VCCINT		AK13		
N/A	VCCINT		AA27		
N/A	VCCINT		AA16		
N/A	VCCINT		Y27		
N/A	VCCINT		Y16		
N/A	VCCINT		W27		
N/A	VCCINT		W16		
N/A	VCCINT		V27		
N/A	VCCINT		V16		
N/A	VCCINT		U27		

Table 13: FF1704 — XC2VP70, XC2VPX70, and XC2VP100

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
N/A	GND		AB18		
N/A	GND		AB17		
N/A	GND		AB11		
N/A	GND		AB8		
N/A	GND		AB5		
N/A	GND		AC41		
N/A	GND		AC26		
N/A	GND		AC25		
N/A	GND		AC24		
N/A	GND		AC23		
N/A	GND		AC22		
N/A	GND		AC21		
N/A	GND		AC20		
N/A	GND		AC19		
N/A	GND		AC18		
N/A	GND		AC17		
N/A	GND		AC2		
N/A	GND		AD26		
N/A	GND		AD25		
N/A	GND		AD24		
N/A	GND		AD23		
N/A	GND		AD22		
N/A	GND		AD21		
N/A	GND		AD20		
N/A	GND		AD19		
N/A	GND		AD18		
N/A	GND		AD17		
N/A	GND		AE37		
N/A	GND		AE34		
N/A	GND		AE26		
N/A	GND		AE25		
N/A	GND		AE24		
N/A	GND		AE23		
N/A	GND		AE22		
N/A	GND		AE21		
N/A	GND		AE20		

Table 13: FF1704 — XC2VP70, XC2VPX70, and XC2VP100

Bank	Pin Description		Pin Number	No Connects	
	Virtex-II Pro Devices	XC2VPX70 (if Different)		XC2VP70, XC2VPX70	XC2VP100
N/A	GND		AU25		
N/A	GND		AU18		
N/A	GND		AU6		
N/A	GND		AV38		
N/A	GND		AV22		
N/A	GND		AV21		
N/A	GND		AV5		
N/A	GND		AW39		
N/A	GND		AW32		
N/A	GND		AW28		
N/A	GND		AW15		
N/A	GND		AW11		
N/A	GND		AW4		
N/A	GND		AY42		
N/A	GND		AY41		
N/A	GND		AY40		
N/A	GND		AY3		
N/A	GND		AY2		
N/A	GND		AY1		
N/A	GND		BA42		
N/A	GND		BA1		
N/A	GND		AA38		
N/A	GND		AA35		
N/A	GND		AA32		
N/A	GND		AA26		
N/A	GND		AA25		
N/A	GND		AA24		
N/A	GND		AA23		
N/A	GND		AA22		
N/A	GND		AA21		
N/A	GND		AA20		
N/A	GND		AA19		
N/A	GND		AA18		
N/A	GND		AA17		
N/A	GND		AA11		
N/A	GND		AA8		

Table 14: FF1696 — XC2VP100

Bank	Pin Description	Pin Number	No Connects
			XC2VP100
3	IO_L38P_3	AE9	
3	IO_L37N_3	AH3	
3	IO_L37P_3	AJ3	
3	IO_L36N_3	AJ1	
3	IO_L36P_3	AJ2	
3	IO_L35N_3	AE6	
3	IO_L35P_3	AE7	
3	IO_L34N_3	AK6	
3	IO_L34P_3	AK7	
3	IO_L33N_3/VREF_3	AK3	
3	IO_L33P_3	AK4	
3	IO_L32N_3	AE12	
3	IO_L32P_3	AF12	
3	IO_L31N_3	AL5	
3	IO_L31P_3	AL6	
3	IO_L30N_3	AL3	
3	IO_L30P_3	AL4	
3	IO_L29N_3	AF10	
3	IO_L29P_3	AF11	
3	IO_L28N_3	AK2	
3	IO_L28P_3	AL2	
3	IO_L27N_3/VREF_3	AL7	
3	IO_L27P_3	AM6	
3	IO_L26N_3	AF7	
3	IO_L26P_3	AF8	
3	IO_L25N_3	AM4	
3	IO_L25P_3	AM5	
3	IO_L24N_3	AM1	
3	IO_L24P_3	AM2	
3	IO_L23N_3	AG10	
3	IO_L23P_3	AG11	
3	IO_L22N_3	AM7	
3	IO_L22P_3	AN7	
3	IO_L21N_3/VREF_3	AN5	
3	IO_L21P_3	AN6	
3	IO_L20N_3	AG8	
3	IO_L20P_3	AG9	